Gas Discharge Tubes(GDT)

3RB-8 Series

Description

GDT is placed in front of, and in parallel with, sensitive telecom equipment such as power lines, communication lines, signal lines and data transmission lines to help protect them from damage caused by transient surge voltages that may result from lightning strikes and equipment switching operations. These devices do not influence the signal in normal operation. However, in the event of an overvoltage surge, such as a lightning strike, the GDT switches to a low impedance state and diverts the energy away from the sensitive equipment.

Our GDT offer a high level of surge protection, a broad voltage range, low capacitance, and many form factors including new surface mount devices, which makes them suitable for applications such as Main Distribution Frame (MDF) modules, high data-rate telecom applications (e.g. ADSL, VDSL), and surge protection on power lines. Their low capacitance also results in less signal distortion. When used in a coordinated circuit protection solution with PolySwitch devices, they can help equipment manufacturers meet stringent safety regulatory standards.



Electrical symbol

Applications

equipment

Data lines

Т

I

L

Т

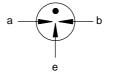
Communication

CATV equipment

Power supplies

Telecom SLIC protection

Broadband equipment

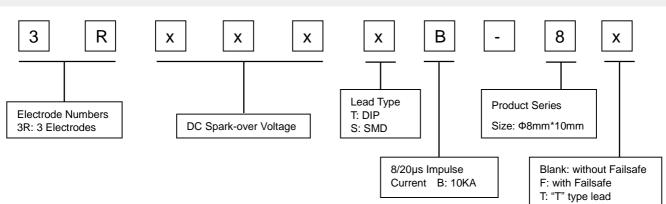


a = Tip b = Ring e = Ground (center electrode)

Features

- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20µs Impulse current capability: 10KA
- I Non-Radioactive
- I Ultra Low capacitance (<1.5pF)
- I High insulation resistance
- I Lead-free compliant
- I RoHS and REACH compliant
- I UL 497B Recognized: E465335
- I Size: Φ8mm*10mm
- I Storage and operational temperature: -40~+90°C

Part Number Code



ADSL equipment, including ADSL2+ XDSL equipment

Т

- I XDSL equipmentI Satellite and CATV
- equipment
- I Test equipment
- I Consumer electronics

Gas Discharge Tubes(GDT)

3RB-8 Series

Electrical Characteristics

						oulse				Life	Ratings	
	Part	Number		DC Spark-over Voltage ^{1) 2) 3)}	Volt	k-over age ³⁾ 1KV/μS	Insulation Resistance ⁴⁾	Capacitance @1MHz	Impulse D Curr @8/20	rent	AC Discharge Current @50Hz 1S ⁵⁾	Impulse Life @10/1000µS 200A ⁵⁾
				@100V/S	Max	Max	Min	Max	Nominal ±5 times	Max 1 time	Nominal 5 times	Min
DIP	SMD	DIP-F	DIP-T	v	v	v	GΩ	pF	KA	KA	А	Times
3R075TB-8	3R075SB-8	3R075TB-8F	3R075TB-8T	75±20%	500	600	1	1.5	10	20	10	300
3R090TB-8	3R090SB-8	3R090TB-8F	3R090TB-8T	90±20%	500	600	1	1.5	10	20	10	300
3R150TB-8	3R150SB-8	3R150TB-8F	3R150TB-8T	150±20%	500	600	1	1.5	10	20	10	300
3R200TB-8	3R200SB-8	3R200TB-8F	3R200TB-8T	200±20%	600	700	1	1.5	10	20	10	300
3R230TB-8	3R230SB-8	3R230TB-8F	3R230TB-8T	230±20%	600	700	1	1.5	10	20	10	300
3R250TB-8	3R250SB-8	3R250TB-8F	3R250TB-8T	250±20%	600	700	1	1.5	10	20	10	300
3R350TB-8	3R350SB-8	3R350TB-8F	3R350TB-8T	350±20%	800	900	1	1.5	10	20	10	300
3R400TB-8	3R400SB-8	3R400TB-8F	3R400TB-8T	400±20%	850	950	1	1.5	10	20	10	300
3R420TB-8	3R420SB-8	3R420TB-8F	3R420TB-8T	420±20%	850	950	1	1.5	10	20	10	300
3R470TB-8	3R470SB-8	3R470TB-8F	3R470TB-8T	470±20%	900	1000	1	1.5	10	20	10	300
3R600TB-8	3R600SB-8	3R600TB-8F	3R600TB-8T	600±20%	1100	1200	1	1.5	10	20	10	300
3R800TB-8	3R800SB-8	3R800TB-8F	3R800TB-8T	800±20%	1400	1500	1	1.5	10	20	10	300
Glow Volta	ge at 10mA.					~60V						
Arc Voltage	e at 1A					~10V						
Glow to Ar	c transition C	Current				~1A						
Operation	and storage	temperature				-40~+90	°C					
Climatic ca	ategory (IEC6	60068-1)				40/90/22	1					
Marking, b	lue negative.					xxx -N	Y Nominal volta Year of prod	-				
Weight						DIP SMD DIP-F DIP-T	~2.10g ~1.85g ~2.35g ~2.15g					
						DIP SMD	-Nickel Plat -Matte-tin p					

¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859

²⁾ In ionized mode

³⁾ Tip or ring electrode to center electrode

⁴⁾ Insulation Resistance Measuring Voltage:

75V at DC 25V 90V~150V at DC 50V Other at DC 100V

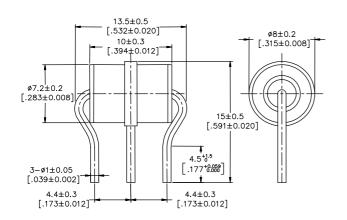
⁵⁾ Total current through center electrode, half value through tip respectively ring electrode.

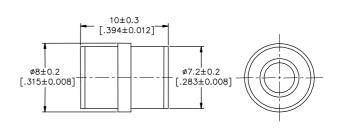
Terms in accordance with ITU-T Rec. K.12, IEC 61643-311, GB/T 9043.

3RB-8 Series

Dimensions (Unit: mm/inch)

DIP Series (3RxxxTB-8)

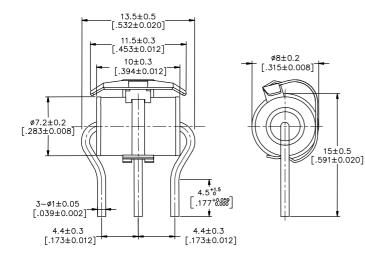


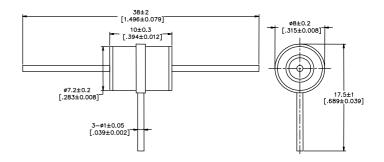


SMD Series (3RxxxSB-8)

DIP-F Series (3RxxxTB-8F)

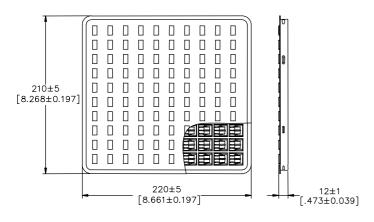
DIP-T Series (3RxxxTB-8T)



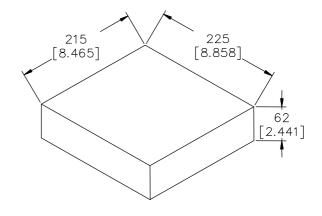


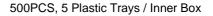
Packaging Information (Unit: mm/inch)

"DIP Series" and "DIP-F Series" Packaging (Bulk)

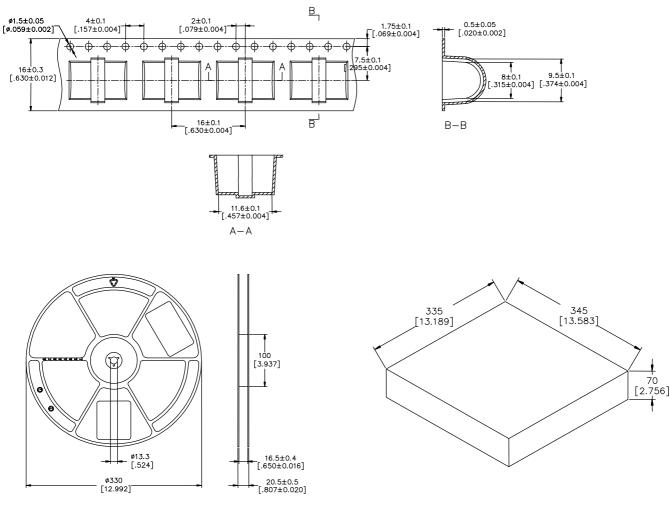


100PCS/ Plastic Tray





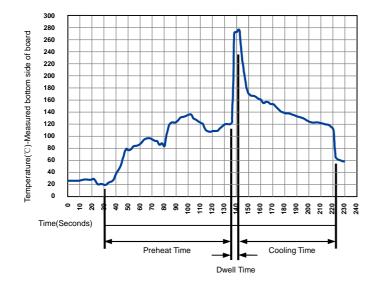
"SMD Series" Packaging (Tape & Reel)



300PCS / Reel

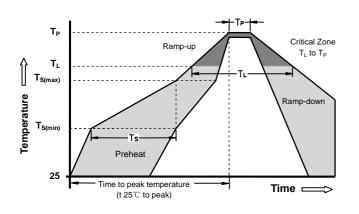
900PCS, 3 Reels / Inner Box

Soldering Parameters - Wave soldering (Thru-Hole Devices)



Wave Sold	lering Condition	Pb-Free assembly			
	Temperature Min	100°C			
Preheat	Temperature Max	150°C			
	Time (Min to Max)	60-180 Seconds			
Solder Pot	Temperature	280°C Max			
Solder Dw	ell Time	2-5 Seconds			

Soldering Parameters - Reflow Soldering (Surface Mount Devices)



Reflow Co	ndition	Pb - Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Preheat	-Temperature Max (T _{s(max)})	200°C		
	- Time (min to max) (t _s)	60 -180 Seconds		
Average ra T _L) to peak	amp up rate (Liquids Temp	3°C/second max		
T _{S(max)} to T	L - Ramp-up Rate	5°C/second max		
Reflow	- Temperature (T∟) (Liquids)	217°C		
	- Time (min to max) (t _s)	60 -150 Seconds		
Peak Tem	perature (T _P)	260 +0/-5°C		
Time withi Temperatu	n 5°C of actual peak ıre (t _p)	10 - 30 Seconds		
Ramp-dow	n Rate	6°C/second max		
Time 25°C	to peak Temperature (T _P)	8 minutes Max		
Do not exc	ceed	260°C		